TOSHIBA MOS DIGITAL INTEGRATED CIRCUIT SILICON GATE CMOS

524.288-WORD BY 8-BIT CMOS STATIC RAM

DESCRIPTION

The TC55V8512JI/FTI is a 4,194,304-bit high-speed static random access memory (SRAM) organized as 524,288 words by 8 bits. Fabricated using CMOS technology and advanced circuit techniques to provide high speed, it operates from a single 3.3 V power supply. Chip enable ($\overline{\text{CE}}$) can be used to place the device in a low-power mode, and output enable ($\overline{\text{OE}}$) provides fast memory access. This device is well suited to cache memory applications where high-speed access and high-speed storage are required. All inputs and outputs are directly LVTTL compatible. The TC55V8512JI/FTI is available in plastic 36-pin SOJ and 44-pin TSOP with 400mil width for high density surface assembly. The TC55V8512JI/FTI guarantees –40° to 85°C operating temperature so it is suitable for use in wide operating temperature system.

FEATURES

- Fast access time (the following are maximum values)
 TC55V8512JI/FTI-12:12 ns
 TC55V8512JI/FTI-15:15 ns
- Low-power dissipation (the following are maximum values)

Cycle Time	12	15	20	25	ns
Operation (max)	180	150	140	120	mA

Standby:10 mA (both devices)

- Single power supply voltage of $3.3~V \pm 0.3~V$
- Fully static operation
- All inputs and outputs are LVTTL compatible
- Output buffer control using \overline{OE}
- Package:

SOJ36-P-400-1.27 (JI) (Weight: 1.35 g typ) TSOP II44-P-400-0.80 (FTI) (Weight: 0.45 g typ)

PIN ASSIGNMENT (TOP VIEW)

(TC55V8512JI)

36 PIN SOJ 44 PIN TSOP

	NC
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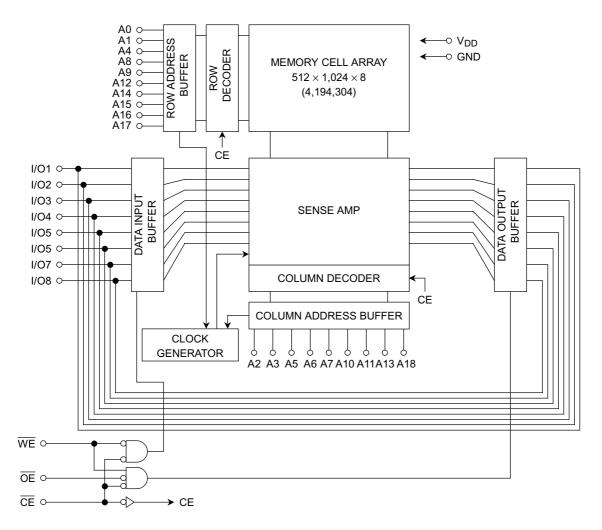
(TC55V8512FTI)

PIN NAMES

A0 to A18	Address Inputs	
I/O1 to I/O8	Data Inputs/Outputs	
CE	Chip Enable Input	
WE	Write Enable Input	
ŌĒ	Output Enable Input	
V_{DD}	Power (+3.3 V)	
GND	Ground	
NC	No Connection	
NU	Not Usable (Input)	



BLOCK DIAGRAM



MAXIMUM RATINGS

SYMBOL	RATING	VALUE	UNIT
V_{DD}	Power Supply Voltage	-0.5 to 4.6	V
V _{IN}	Input Terminal Voltage	−0.5* to 4.6	V
V _{I/O}	Input/Output Terminal Voltage	−0.5* to V _{DD} + 0.5**	V
P _D	Power Dissipation	1.4	W
T _{solder}	Soldering Temperature (10s)	260	°C
T _{stg}	Storage Temperature	-65 to 150	°C
T _{opr}	Operating Temperature	-40 to 100	°C

^{*: -1.5} V with a pulse width of 20% t_{RC} min (4 ns max)

DC RECOMMENDED OPERATING CONDITIONS (Ta = -40° to 85°C)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
V_{DD}	Power Supply Voltage	3.0	3.3	3.6	V
V _{IH}	Input High Voltage	2.0	_	V _{DD} + 0.3**	V
V _{IL}	Input Low Voltage	-0.3*	_	0.8	V

^{*: –1.0} V with a pulse width of 20% \cdot $t_{\mbox{\scriptsize RC}}$ min (4 ns max)

^{**:} V_{DD} + 1.5 V with a pulse width of 20% \cdot t_{RC} min (4 ns max)

^{**:} V_{DD} + 1.0 V with a pulse width of 20% t_{RC} min (4 ns max)



DC CHARACTERISTICS (Ta = -40° to 85°C, V_{DD} = 3.3 V \pm 0.3 V)

SYMBOL	PARAMETER	TEST CONDITION		MIN	TYP	MAX	UNIT
I _{IL}	Input Leakage Current (Except NU pin)	V _{IN} = 0 to V _{DD}		-1	_	1	μΑ
I _{LO}	Output Leakage Current	$\overline{CE} = V_{IH} \text{ or } \overline{WE} = V_{IL} \text{ or } \overline{OE} = V_{IH},$ $V_{OUT} = 0 \text{ to } V_{DD}$		-1	_	1	μΑ
	Input Current	V _{IN} = 0 to 0.8 V		-1	_	20	
l _I (NU)	(NU pin)	V _{IN} = 0 to 0.2 V		-1	_	1	μΑ
.,	Out and I link Walter	$I_{OH} = -2 \text{ mA}$		2.4	_		
V _{OH}	Output High Voltage	$I_{OH} = -100 \mu\text{A}$		V _{DD} – 0.2	_	_	.,
.,		I _{OL} = 2 mA		_	_	0.4	V
V _{OL}	Output Low Voltage	I _{OL} = 100 μA		_	_	0.2	
			t _{cycle} = 12 ns	_	_	180	
	On a matting of Command	$\overline{CE} = V_{IL}, I_{OUT} = 0 \text{ mA},$	t _{cycle} = 15 ns	_	_	150	^
I _{DDO}	Operating Current	$\overline{OE} = V_{IH},$ Other Input = V_{IH}/V_{II}	t _{cycle} = 20 ns	_	_	140	mA
		Othor mpac VIII/VIL	t _{cycle} = 25 ns	_	_	120	
I _{DDS1}	Ot a will be O would	CE = V _{IH} , Other Input = V _{IH} or V _{IL}		_	_	55	
I _{DDS2}	Standby Current	$\overline{CE} = V_{DD} - 0.2 \text{ V}$, Other Input = V_{DD} -	- 0.2 V or 0.2 V	_	_	10	mA

CAPACITANCE (Ta = 25°C, f = 1.0 MHz)

SYMBOL	PARAMETER	TEST CONDITION	MAX	UNIT
C _{IN}	Input Capacitance	V _{IN} = GND	6	pF
C _{I/O}	Input/Output Capacitance	$V_{I/O} = GND$	8	pF

Note: This parameter is periodically sampled and is not 100% tested.

OPERATING MODE

MODE	CE	ŌĒ	WE	I/O1 to I/O8	POWER
Read	L	L	Н	Output	I _{DDO}
Write	L	*	L	Input	I _{DDO}
Outputs Disable	L	Н	Н	High Impedance	I _{DDO}
Standby	Н	*	*	High Impedance	I _{DDS}

^{* :} Don't care

Note: The NU pin must be left unconnected or tied to GND or a voltage level of less than 0.8 V. You must not apply a voltage of more than 0.8 V to the NU.



<u>AC CHARACTERISTICS</u> (Ta = -40° to 85°C ^(See Note 1), $V_{DD} = 3.3 \text{ V} \pm 0.3 \text{ V}$)

READ CYCLE

			TC55V8	512JI/FTI		
SYMBOL	BOL PARAMETER		-12		15	UNIT
		MIN	MAX	MIN	MAX	Ī
t _{RC}	Read Cycle Time	12	_	15	_	
t _{ACC}	Address Access Time	_	12	_	15	
t _{CO}	Chip Enable Access Time	_	12	_	15	
t _{OE}	Output Enable Access Time	_	6	_	8	
t _{OH}	Output Data Hold Time from Address Change	3	_	4	_	ns
t _{COE}	Output Enable Time from Chip Enable	3	_	4	_	
toee	Output Enable Time from Output Enable	1	_	1	_	
t _{COD}	Output Disable Time from Chip Enable	_	7	_	8	
t _{ODO}	Output Disable Time from Output Enable	_	7	_	8	

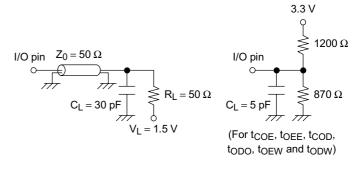
WRITE CYCLE

					TC55V8512JI/FTI			
SYMBOL	BOL PARAMETER		12		15	UNIT		
		MIN	MAX	MIN	MAX			
t _{WC}	Write Cycle Time	12	_	15	_			
t _{WP}	Write Pulse Width	8	_	9	_			
t _{CW}	Chip Enable to End of Write	10	_	12	_			
t _{AW}	Address Valid to End of Write	10	_	12	_			
t _{AS}	Address Setup Time	0	_	0	_	ns		
t _{WR}	Write Recovery Time	0	_	0	_	115		
t _{DS}	Data Setup Time	7	_	8	_			
t _{DH}	Data Hold Time	0	_	0	_			
t _{OEW}	Output Enable Time from Write Enable	1		1				
t _{ODW}	Output Disable Time from Write Enable	_	7	_	8			

AC TEST CONDITIONS

PARAMETER	TEST CONDITION
Input Pulse Level	3.0 V/ 0.0 V
Input Pulse Rise and Fall Time	2 ns
Input Timing Measurement Reference Level	1.5 V
Output Timing Measurement Reference Level	1.5 V
Output Load	Fig.1

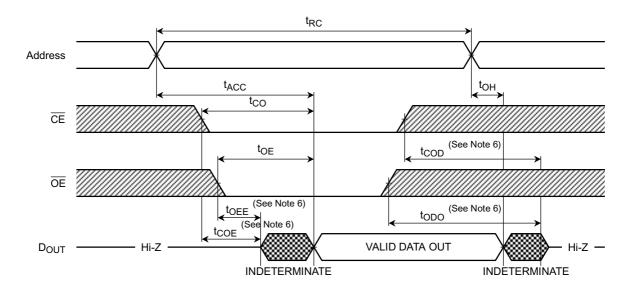
<u>Fig.1</u>



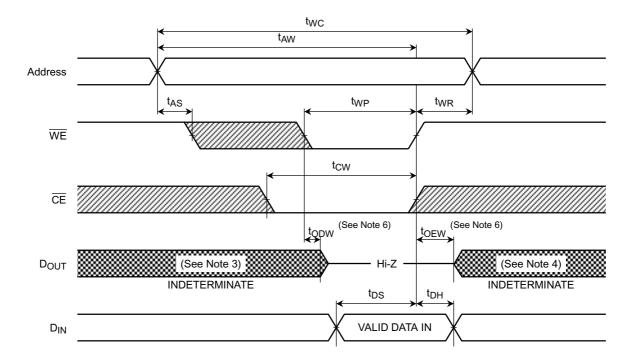


TIMING DIAGRAMS

READ CYCLE (See Note 2)

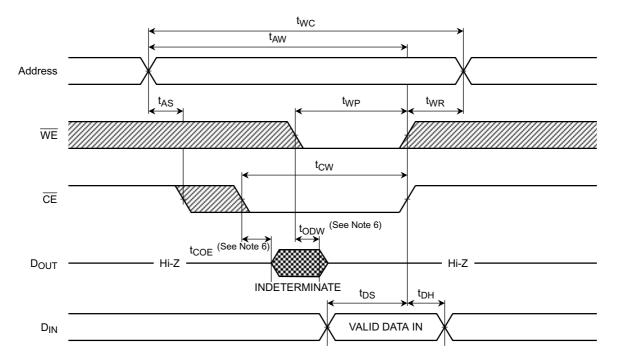


WRITE CYCLE 1 (WE CONTROLLED) (See Note 5)



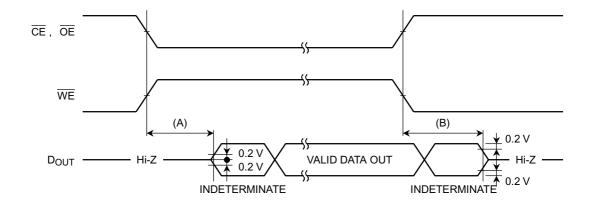


WRITE CYCLE 2 (CE CONTROLLED) (See Note 5)



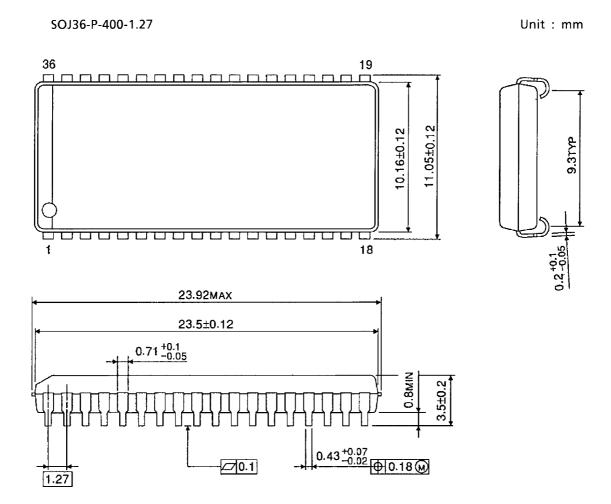
Note:

- (1) Operating temperature (Ta) is guaranteed for transverse air flow exceeding 400 linear feet per minute.
- (2) WE remains HIGH for the Read Cycle.
- (3) If $\overline{\text{CE}}$ goes LOW coincident with or after $\overline{\text{WE}}$ goes LOW, the outputs will remain at high impedance.
- (4) If $\overline{\text{CE}}$ goes HIGH coincident with or before $\overline{\text{WE}}$ goes HIGH, the outputs will remain at high impedance.
- (5) If \overline{OE} is HIGH during the write cycle, the outputs will remain at high impedance.
- (6) The parameters specified below are measured using the load shown in Fig.1.
 - (A) tCOE, tOEE, tOEW · · · · · Output Enable Time
 - (B) t_{COD} , t_{ODO} , t_{ODW} Output Disable Time





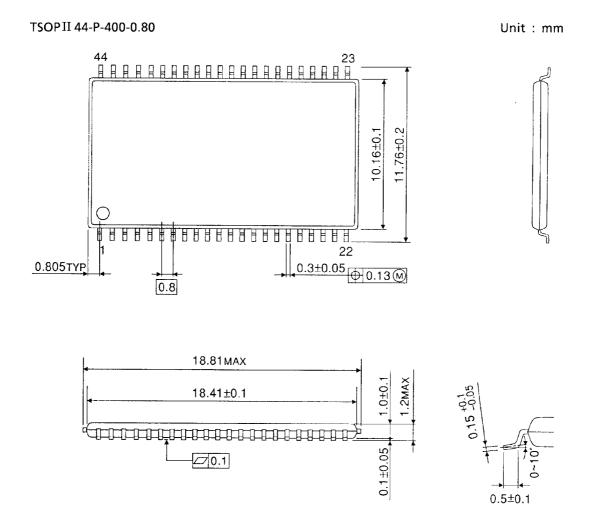
PACKAGE DIMENSIONS



Weight: 1.35 g (typ)



PACKAGE DIMENSIONS



Weight: 0.45 g (typ)

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